Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.								
IPC Web Site for Information on IPC-1752 Standard Form Typ			Form Type * Distribute	 * Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi 					als and Mfg Information			
Supplier Information												
Company name* Company unique ID				Unique ID Authority				Response Date*				
nsemi									2025-05-14			
Contact Name	act Name Title - Contact			1	Phone - Contact*				Email - Contact*			
Product-Env-Stewards Product Enviro Compliance					NA				Product-Env-Stewards@onsemi.com			
Authorized Representative* Title - Representative				1	Phone - Representative*				Email - Representative*			
Product-Env-Stewards	Product Envir	roduct Enviro Compliance			NA				Product-Env-Stewards@onsemi.com			
Requester Item Number N	Afr Item Number	Mfr Item Name			Effective Date	Version	N	Manufacturing Site		Weight*	UOM	Unit Type
	MC74VHC1G50P5T5 G-L22088	HC1G50P5T5 Single Buffer			2025-05-14				1	1.19	mg	Each
Manufacturing Proccess Information												
Terminal Plating / Grid Array Material	Terminal Base A	Ferminal Base Alloy J-STD-020 MS			Peak Process Body Temperature Max Time at Pea			Temperature Number of Reflow Cycles				
Matte Tin (Sn) - annealed CU Alloy			1		260 C		С	30	secon	ds 3		
Comments												
level 1 - maximum time at peak temperature du	ring soldering is 10-3) seconds										
For more information regarding material comp	osition please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		nium (Cr6+), Polybro	ominated Biphenyls (PBB), Polybron	dmium and quantity limit of 0.1% by mass (100 minated Diphenyl Ethers (PBDE), and Bis(2-eth						
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.										
Supplier Digital Signature Ra	stislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

sigma range of distribution unless	otherwise noted).				-			
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.03	mg	Supplier	Silicon (Si)	7440-21-3		0.03	mg
Lead Frame	0.52	mg	Supplier	Silver (Ag)	7440-22-4		0.0926	mg
			В	Nickel (Ni)	7440-02-0		0.1607	mg
			Supplier	Iron (Fe)	7439-89-6		0.222	mg
			Supplier	Copper (Cu)	7440-50-8		0.0447	mg
Mold Compound-Black	0.6	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.06	mg
			Supplier	Carbon Black (C)	1333-86-4		0.003	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.087	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		0.39	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.06	mg
Plating	0.02	mg	Supplier	Tin (Sn)	7440-31-5		0.02	mg
Wire Bond - Au	0.02	mg	Supplier	Gold (Au)	7440-57-5		0.02	mg